

SPECIFICATION FOR TFT MODULE

MODULE NO.: IPS050A104S

Rev No.: O

GTK	PREPARED BY	CHECKED BY	APPROVED BY
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DATE	2020.10.08	2020.10.08	2020.10.08

	SIGNATURE	DATE
CUSTOMER APPROVAL		

Notes:

- 1. Please contact GTK before assigning your product based on this module specification.
- 2. To improve the quality of product, and this product specification is subject to change without any notice.

REVISION RECORD

Rev No.	Rev date	Contents	Remarks
0	2020.10.08	First release	Preliminary
	l		

CONTENTS

1. GENERAL INFORMATION	3
2. ABSOLUTE MAXIMUM RATINGS	3
3. ELECTRICAL CHARACTERISTICS	4
4. BACKLIGHT CHARACTERISTICS	4
5. EXTERNAL DIMENSIONS	5
6. ELECTRO-OPTICAL CHARACTERISTICS	6
7. INTERFACE DESCRIPTION	8
8. AC CHARACTERISTICS	9
9. POWER SEQUENCE	11
10. RELIABILITY TEST CONDITIONS	12
11.INSPECTION CRITERION	13
12. HANDLING PRECAUTIONS	20
13. PRECAUTION FOR USE	21
14. PACKING SPECIFICATION	21
15. INITIALIZATION CODE	21
16 HSE COMPLIANCE	21

1. GENERAL INFORMATION

No.	Item	Contents	Unit
1	LCD size	5.0 inch (Diagonal)	/
2	Display mode	IPS / NORMALLY BLACK / TRANSMISSIVE(ANTI-GLARE)	1
3	Viewing direction(eye)	FREE	/
4	Gray scale inversion direction	-	/
5	Resolution(H*V)	800*480 Pixels	/
6	Module size (L*W*H)	121.00*78.80*7.00	mm
7	Active area (L*W)	108.00*64.80	mm
8	Pixel pitch (L*W)	0.135*0.135	mm
9	Interface type	RGB interface	/
10	Color Depth	16.7M	/
11	Module power consumption	TBD	W
12	Back light type	LED	/
13	Driver IC	ST7262 OR COMPATIBLE	/
14	Weight	TBD	G

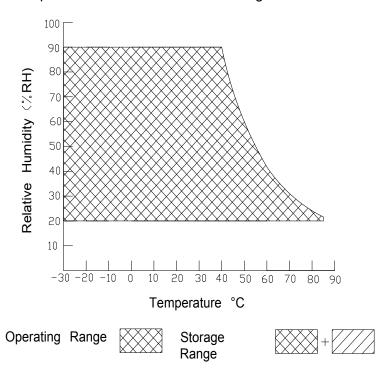
2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit	Note
Power supply input voltage for TFT	VCC	-0.3	4.0	V	
Backlight current (normal temp.)	ILED	-	175	mA	
Operation temperature	Тор	-30	85	°C	Note1
Storage temperature	Tst	-30	85	°C	Note1
Humidity	RH	-	90%	RH	Note1

Note1:

1). The relative humidity and temperature range are as below sketch, 90%RH Max.

2). The maximum wet bulb temperature $\leq 40^{\circ}$ C and without dewing.





3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Power supply input voltage	VCC	3.3	3.3	3.6	V	
I/O logic voltage	IOVCC	-	-	-	V	
Input voltage 'H' level	VIH	0.7VCC	-	VCC	V	
Input voltage 'L' level	VIL	VSS	-	0.3VCC	V	
Power supply current	IVCC	-	TBD	-	mA	

4. BACKLIGHT CHARACTERISTICS

(at Ta=25°C,RH=60%)

, , , , , , , , , , , , , , , , , , , ,						
Item	Symbol	Min.	Тур.	Max.	Unit	Note
LED forward voltage	VF	18.5	21.0	22.8	V	
LED forward current	IF	-	140	-	mA	IF=70*2mA
LED power consumption	PLED	-	2.94	-	W	Note1
Number of LED	-		14		PCS	
Connection mode	-	7 in se	ries 2 in para	ıllel	1	
LED life-time	-	30000	_	-	Hrs	Note2

Note1 : Calculator value for reference : IF*VF = PLED

Note2 : The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =140mA. The LED lifetime could be decreased if operating IF is larger than 140mA

P. 4

5. EXTERNAL DIMENSIONS m \circ | Company | Comp SEP-25-2020 SEP-25-2020 SEP-25-2020 SEP-25-2020 DATE DATE SEP-02-(370H M3H0S) H9-S:0*EM-p 9 高速 NAME サナなが 工作 NAME 中華山 (0) -00.r -43.45 ± 0.50 →LEDK2 CONSTANT CURRENT:140mA,21.0V(REF.) BACKLIGHT DRIVER CIRCUIT DIAGRAM CHECKED ⊕ DRAWN TAPE TAPE (**黄色高幽胶带**) - BLACK -*104.60±0.15 (78.60)Ω Ľ UNMARKED TOLERANCE ±0.30 ШШ TFT MODULE -08.0±00.8* (78.24) ROHS/REACH COMPLIANT LINO AREA REV. -72,13 BENDINGE $-P0.50*(50-1)=24.50\pm0.05$ REV. SYMBOL DESCRIPTION MARK**ARE IMPORTANT DIMENSIONS,MARK*()'ARE REFERENCE DIMENSIONS,MARK**ARE SPECIAL CHARACTERISTICS RELATED TO SAFETY,MARK*A*(CUSTOMER NO. ARE SPECIAL CHARACTERISTICS IRRELEVANT TO SAFETY,MARK*@*ARE IMPORTANT CHARACTERISTICS EXCEPT FOR THE SPECIAL CHARACTERISTICS. FIRST ISSUE MODULE NO. $+25.50\pm1.00$ Н 1 OF PART NO. UPDATE TITLE SCALE SHEET 1 (P) (P) 8.20±0.20--81.0±05.263* -06.0±03.75 -(20.1) < MATE WITH CONNECTOR: FH28D-50S-0.5SH 10.40±0.20- $-4-3.00\pm0.10$ 7 COMPATIBLE ★7.00±0.30 ---*0.30±0.05 -STIFFENER COMPONENT ⋖ 0 DETAIL A SCALE: 2/1 +85°C -30°C TO +85°C --27.10±0.10---*25.50±0.10-PARAMETERS ST7262 OR EDGE,WHITE Þ 2 CONTACT SIDE FRONT -30°C TPULL TAPE FREE 50 OPERATING TEMPERATURE *0.50±0.10 VIEWING DIRECTION(EYE) TEMPERATURE -(21.42)-1 CONNECTOR BACKLIGHT STORAGE -\$121.00±0.30(OUTLINE)-**110.60±0.20(BEZEL V.A) ----108.00(LCD A.A)-----TEM PIXELS FRONT BACK TRANSMISSIVE(ANTI-GLARE) ₫ FRONT BACK 5.0 inch 800*480 IPS/NORMALLY BLACK 5.0 inch(DIAGONAL) 800*480 PIXELS (60.80)**PARAMETERS** +(12.82)POWER SUPPLY INPUT VOLTAGE 3.3V(VCC) ₫ *5.50-(6.80)-(02.95)#78.80±0.30(OUTLINE)— -*77.80±0.30 -*67.40±0.20(BEZEL V.A)-64.80(LCD A.A) (08.Σ) VOLTAGE D RESOLUTION(H*V) POLARIZER TYPE LOGIC FRONT LCD SIZE LCD TYPE BACK TEM ⋖ \Box \circ

6. ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response time	Tr+ Tf		-	30	-	ms	FIG.1	Note 1
Contrast ratio	Cr	-	1000	1300	-	-	FIG.2	Note 2
Surface luminance	Lv	θ=0°	800	1000	-	cd/m ²	FIG.2	Note 3
Luminance uniformity	Yu	θ=0°	75	80	-	%	FIG.2	Note 4
NTSC	-	θ=0°	-	50	-	%	FIG.2	Note 5
		∅=90°	70	80	-	deg	FIG.3	Note 6
Viewing angle	θ	Ø=270°	70	80	-	deg	FIG.3	
Viewing angle		∅=0°	70	80	-	deg	FIG.3	
		∅=180°	70	80	-	deg	FIG.3	
	Red x			TBD		-		
	Red y			TBD		-	FIG.2	Note 5
	Green x			TBD		-		
CIE (x,y)	Green y	θ=0° ∅=0°	Тур	TBD	Тур	-		
chromaticity	Blue x	7	-0.04	TBD	+0.04	-	CIE1931	Note 5
	Blue y	14 20 0		TBD		-	1	
	White x			TBD	1	-		
	White y			TBD		-		

Note1. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

Note2.Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= Luminance measured when LCD on the "White" state
Luminance measured when LCD on the "Black" state

Measured at the center area of the LCD

Note3.Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note4.Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

 $Y_{u} = \frac{\text{Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}{\text{Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}$

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

FIG.1. The definition of response Time

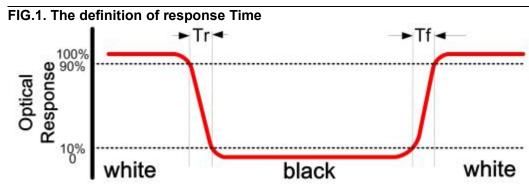


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

H,V: Active area

Light spot size \varnothing =5mm(BM-5) or \varnothing =7.7mm (BM-7)50cm distance or compatible distance from the LCM surface to detector lens.

Test spot position : see Figure a.

measurement instrument: TOPCON's luminance meter BM-5 or BM-7 or compatible, see Figure b.

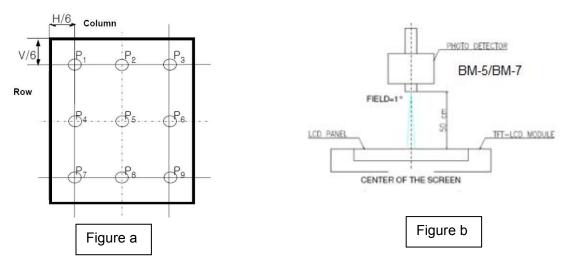
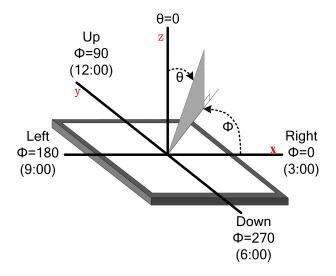


FIG.3. The definition of viewing angle



7. INTERFACE DESCRIPTION

Module Interface description

Interface No.	rface descrip Name	I/O or connect to	Description				
1	LEDK2	Р	Power for LED backlight(Cathode)				
2	LEDK1	Р	Power for LED backlight(Cathode)				
3~4	LEDA	Р	Power for LED backlight(Anode)				
5	NC	1	1				
6	GND	Р	Ground				
7	VDD_MTP	Р	POWER FOR OTP programming, please leave the pin open when not in use				
8	ROM_RLB	Р	Ground				
9	SDA	I/O	Serial interface date				
10	SCL	I	Serial interface clock				
11	LR	I	Source right or left sequence control				
12	UD	I	gate up or down scan control				
13~14	VCC	Р	Power for LCD				
15	GND	Р	Ground				
16	DE	I	Data enable				
17	HSYNC	I	Horizontal sync input				
18	VSYNC	I	Vertical sync input				
19	GND	Р	Ground				
20	CLK	I	Dot clock				
21	GND	Р	Ground				
22~29	Blue(7~0)	I	Blue data				
30	GND	Р	Ground				
31~38	Green(7~0)	I	Green data				
39	GND	Р	Ground				
40~47	Red(7~0)	I	Red data				
48	GND	Р	Ground				
49	RESET	I	LCD RESET signal				
50	STBYB	I	Standby mode, Normally pulled high				

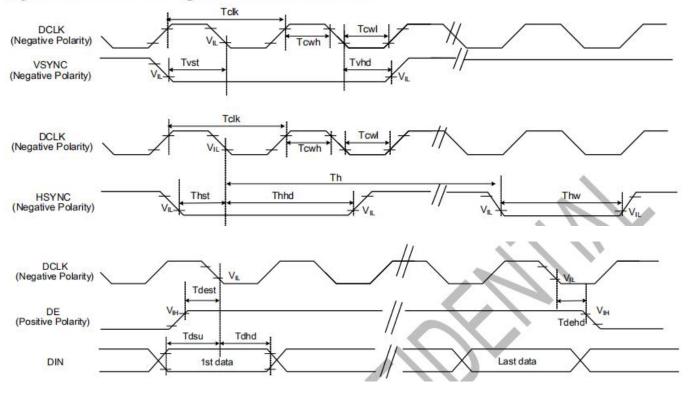
8.AC CHARACTERISTICS

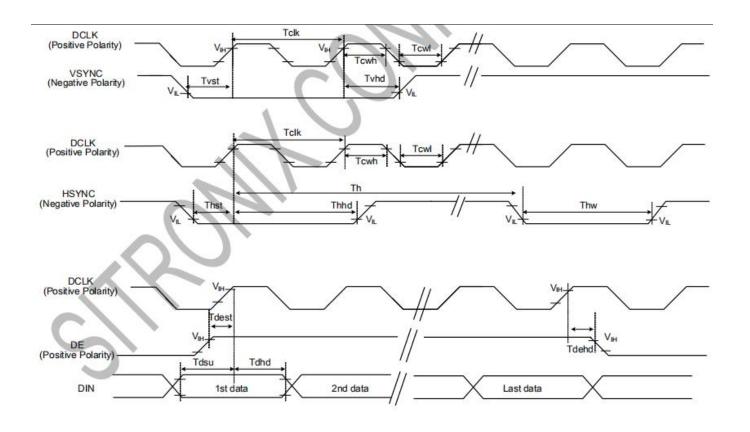
AC Electrical Characteristics (PVDD=VDD=VDDI= 3.3V, AGND= 0V, TA=25°C, Bare Chip)

System Operation AC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Conditions
VDD Power Source Slew Time	TPOR	-	-	20	ms	From 0V to 99% VDD
GRB Pulse Width	tRSTW	10	50	-	us	R=10Kohm, C=1uF
SD Output Stable Time	Tst	1570	-	TBD	us	Output settled within +20mV Loading = 6.8k+28.2pF.
GD Output Rise and Fall Time	Tgst	-		TBD	us	Output settled (5%~95%), Loading = 4.7k+29.8pF

System Bus Timing for RGB Interface



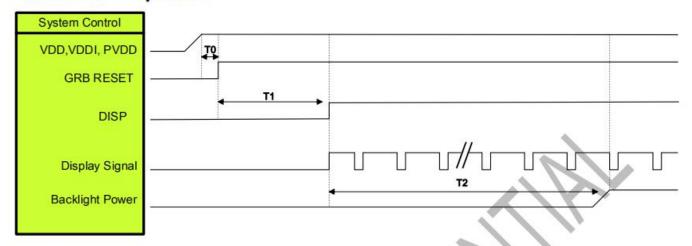


Item	Symbol	Min.	Тур.	Max.	Unit	Conditions
CLK Pulse Duty	Tcw	40	50	60	%	
HSYNC Width	Thw	2	-	-	DCLK	
HSYNC Period	Th	55	60	65	us	
VSYNC Setup Time	Tvst	12	-	-	ns	
VSYNC Hold Time	Tvhd	12	-	-	ns	
HSYNC Setup Time	Thst	12	-	-	ns	
HSYNC Hold Time	Thhd	12	-	-	ns	
Data Setup Time	Tdsu	12	-	-	ns	
Data Hold Time	Tdhd	12	ī .	-	ns	
DE Setup Time	Tdest	12	7-	-	ns	
DE Hold Time	Tdehd	12	-	-	ns	

9. POWER SEQUENCE

To prevent the device damage from latch up and Improve subjective display effect, the power ON/OFF sequence shown below must be followed.

Power On Sequence

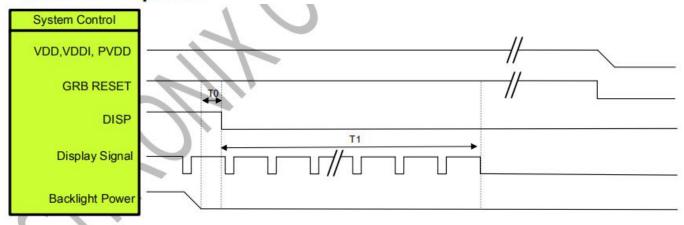


Symbol	Description	Min. Time	Unit
T0	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

Note: RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DB[7:0]; DB[7:0]

Note: LVDS interface Display signal: DCLK P/N; RX[3:0]P/N

Power Off Sequence



Symbol	Description	Min. Time	Unit
T0	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	100	ms

Note: RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]

Note: LVDS interface Display signal: DCLK P/N; RX[3:0]P/N

10. RELIABILITY TEST CONDITIONS

No.	Test item	Test con	dition	Inspection after test
10.1	High temperature storage test	+85°C/500 hours		
10.2	Low temperature storage test	-30°C/500 hours		
10.3	High temperature operating test	+85°C/500 hours	+85°C/500 hours	
10.4	Low temperature operating test	-30°C/500 hours		Inspection after
10.5	Temperature cycle storage test	-30°C ~ 25°C ~ +85°C/40cycles coom te		2~4hours storage at room temperature, the sample shall be free
10.6	High temperature high humidity test	+60°C*90% RH/240 hours		from defects : 1.Current changing
10.7	Vibration test	Frequency : 250 r/min Amplitude : 1 inch Time: 45min		value before test and after test is 50% larger; 2. Function defect :
		Drop direction: 1 corner/3 edges/6 sides 10 times		Non-display,abnormal-d isplay,missing lines, Short lines,ITO
		Packing weight(kg)	Drop height(cm)	corrosion;
10.8	Drop test	<11	80±1.6	3.Visual defect : Air bubble in the LCD,Seal
	2.56	11≦G<21	60±1.2	leak,Glass crack.
		21≦G<31	50±1.0	
		31 ≦ G<40	40±0.8	
10.9	ESD test	Air discharge: ±8KV, 10times Contact discharge: ±4KV, 10times		

Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 3~5pcs.
- 3. For High temperature high humidity test, Pure water(Resistance>10M Ω) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.B/L evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence B/L has.
- 6. Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.
- 7. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

11.INSPECTION CRITERION

11.1 Objective

The TFT test criterion are set to formalize TFT quality standards for GTK with reference to those of the customer for inspection, release and acceptance of finished TFT products in order to guarantee the quality of TFT products required by the customer.

11.2 Scope

The criterion is applicable to all the TFT products manufactured by GTK.

11.3 Equipment for Inspection

Electrical tester, electrical testing machines, vernier calipers, microscopes, magnifiers, anti-static wrist straps, finger cots, labels, tri-phase cold and hot shock machine, constant temperature and humidity chamber, backlight table, ovens for high-low temperature experiments, refrigerators, constant voltage power supply (DC), desk Lamps, etc.

11.4 Sampling Plan and Reference Standards

11.4.1.1 Sampling plan

Refer to National Standard GB/T 2828.1---2012/ISO2859-1:1999, level II of normal levels:

Product Category	Consumer Electronics	Non-consumer Electronics	Industrial	Automobile
AQL	MA=0.4 MI=1.5	MA=0.4 MI=1.0	MA=0.25 MI=0.65	MA=0.15 MI=0.40

11.4.1.2 GB/T 2828.1---2012/ISO2859-1:1999 Sampling check procedure in count

11.4.1.3 GB/T 18910. Standard for LCM parts

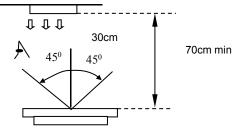
11.4.1.4 GB/T24213-2008 Basic Environmental Test Procedures for Electrical and Electronic Products

11.4.1.5 IPC-A-610E Acceptability of Electronic Assemblies

11.5 Inspection Conditions and Inspection Reference

11.5.1Cosmetic inspection: shall be done normally at $23\pm5^{\circ}$ C of the ambient temperature and 45~75%RH of relative humidity, under the ambient luminance between 500lux~1000lux and at the distance of 30cm apart between the inspector's eyes and the LCD panel and normally in reflected light. For backlight LCM, cosmetic inspection shall be done under the ambient luminance less than 100lux with the backlight on.

11.5.2 The TFT shall be tested at the angle of 45° left and right and 0-45° top and bottom as the following picture showing:





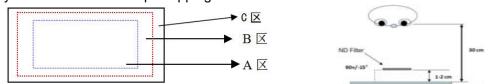
11.5.3 Definition of viewing area (VA)

A area: Active area (AA area)
B area: Viewing area (VA area)

C area: Non-viewing area (not viewing after customer assembly)

If there is any appearance viewing defect which do not affect product quality and customer assembly in C area, it's accepted in generally.

The criteria apply to A and B area except chipping and crack.



11.5.4 Inspection with naked eyes(exclusive of the inspection of the physical dimensions of defects carried out with magnifiers)

11.5.5 ND card use method(refer to right conner image) and scope: Multi-bright dot; Mura(Black/Gray pattern uneven); dark line and so on.

11.5.6 Undefined items or other special items, refer to mutual agreement and limited sample. If criterion does not match product specifications/ technical requirement, both should be subject to special inspection criterion agreed by customer.

11.6 Defects and Acceptance Standards

11.6.1 Electrical properties test

11.6.1.1 Test voltage(V): Refer to the instruction of testers and the product specification or drawing and the display content and parameters and display effects shall conform to the product specification and drawing.

11.6.1.2 Current Consumption(I): Refer to approved product specifications or drawings.

11.6.1.3 Function items(Defect category MA)

11.0.1.0	discion items(Detec	occessivity			
No.	Defects	Descriptions	Pictures	Inspection method/tools	Defect category
11.6.1.3 .1	No display /reaction	shows no picture/display in normal connected situation.		Naked eyes/ testers	MA
11.6.1.3 .2	Missing segment	Shows missing lines in normal display		Naked eyes/ testers	MA
11.6.1.3 .3	Dark line	Only visible on gray pattern, 1 or more vertical/horizontal lines: 5%ND, not visible, OK	1	Naked eyes/ testers	MA
11.6.1.3 .4	POL angle defect	Not accepted	正常 POL贴反180度后	Naked eyes/ testers	MA
11.6.1.3 .5	Image retention (sticking)	Chess pattern stays for 30mins and change to 50% gray pattern, disappear in 10s, OK; if time>10s, NG		Naked eyes/ testers	MA
11.6.1.3 .6	Flicker	Refer to Limit sample if essential or flicker value <-30dB (measured by CA310A); OK		Naked eyes/ CA310A	MA
11.6.1.3 .7	Display abnormal	Not accepted		Naked eyes/ testers	MA
11.6.1.3 .8	Cross-talk	Refer to limited sample	+	Naked eyes/ limited sample	MA
11.6.1.3 .9	Display dim/bright	Refer to limited sample	1	Naked eyes/ limited sample	MA
11.6.1.3 .10	Contrast	Refer to limited sample	1	Naked eyes/ limited sample	MA
11.6.1.3 .11	Huge current	Out of spec, not accepted	1	Ammeter	MA
11.6.1.3 .12	TP function defect	Not accepted	/	Naked eyes/ Touch/ test program	MA

11.6.2 LCD dot/line defect

11.6.2.1 LCD pixel dot defect(defect category: MI)

Item		Inspectio	n criterion	
Size	S <5"	5≤S<10"	10≤S<15"	<u>S≥15"</u>
Color pixel dot defect(RGB dot)	1	2	2	<u>3</u>
2 connected bright dot	0	1	1	<u>1</u>
3 connected bright dot or more	0	0	1	<u>0</u>
Bright dot quantity	1	2	3	<u>4</u>
Random dark dot quantity	2	3	4	<u>5</u>
2 connected dark dot	1	1	2	<u>2</u>
3 connected dark dot or more	0	0	0	<u>0</u>
Dark dot quantity	3	4	5	<u>6</u>
Multi-bright dot		ND 5% h	idden, OK	

Remark: 2 bright dots distance DS≥15mm 2 dark dots distance DS≥5mm

- 1) Bright dot: Power on TFT and RGB dot in black display
- 2) Dark dot: Power on TFT and gray or black dot in RGB display
- 3) Multi-bright dot: Power on TFT and fluorescent tiny dot in black display(only visible in black display)

11.6.2.2 LCD appearance dot defect (defect category: MI)

11.0.2.2 L	ob appea		ot detec	ι (d	efect catego					<u> </u>
No	Item				Inspection				Picture	Inspection
No.	item	Size		S	<5"	5≤S< 10"	10≤S< 15"	S≥15"	ricture	method/tools
		D≤0.15		igr	nore	ignore	D≤0.2;			
		0.15				Not	D≤0.2;			
		<			3	3	count	ignore		
		D≤0.25								Naked eyes
		0.25			4	0				/film card
	Dot	< D≤0.30			1	2	00005	0 0 0 0 5	\$ b	/magnifier
	defect						0.2~0.35 Q'ty ≤4			
11.6.2.2.1	(black	0.30			0	1	Q ty ≥4	Q'ty ≤ 5	'a'	
11.0.2.2.1	dot,	D≤0.35			U	ı			D=(a+b)/2	
	white	0.35							D=(a+b)/2	
	dot)	< 0.55			0	0	1	2		
		D≤0.50				· ·	•	_		
		D>			•	•				
		0.5			0	0	0	0		
			Re	mar	rk: D≤0.15m	m, not co	unt. Multi-d	dot as bulk	s is not accepte	ed.
			ount dot	qua	antity≤ 5; 2 r	ound dots	or linear	dots in 1 c	m is judged as	multi-dot.
		Length	Widtl	- 1	S <5"	5≤S<	10≤S<	S≥15"		
		(mm)	(mm)		10"	15"	0=10		
		Not	W≤0.0	3	Ignored	Ignored	Ignored	Ignored		
		count	0.03≤′	۸/						
	Line	L≤5	<0.03	- 1	3	3	Ignored	Ignored	•	Naked eyes
	defect (visible		0.05≤							/film card
11.6.2.2.2	when	L≤5	< 0.08		0	1	3	3	_ L _ \ W	/magnifier
	power		0.05≤	_				_	*	
	on)	L≤8	<0.08	- 1	0	0	1	2		
		1 > 0	W>		•	•	0	_		
		L>8	0.08		0	0	0	0		
		Rema	ark: In	/isib	le when pov	wer on, or	nly visible i	n special a	angle against li	ght, show as
		watern	nark/fol	ding	/scratch but	can not b	e touched	, no contro	ol or refer to ke	eping sample.
		Size(r	mm)	ç	S <5"	5≤S<	10≤S<	S≥15"		
	Polarizer	,	·			10"	15"			
	convex-	D≤0.		Ις	gnored	Ignored	Ignored	Ignored		
	concave	0.20	I		2	2	3	5	\$b	Naked eyes
11.6.2.2.3	dot	D≤0.								/film card
11.0.2.2.0	аетест,	0.50			0	1	2	3	a f	/magnifier
	polarizer									
	bubble defect	0.8 ⁻ D≤1.			0	0	1	2		
	GOIGGE				0		0	_		
		D>1.5	וווווו		0	0	0	0		

No.	Chipping defect Item		Accepte	d criterion(mm))	MAJ	MIN
	ITO conductive side	Х	1	≤1/8L	1		
11.6. 3.1	Z Z	Y	Y≤1/6W	1/6W <y≤1 4w<="" td=""><td>1/4W <y< td=""><td></td><td>$\sqrt{}$</td></y<></td></y≤1>	1/4W <y< td=""><td></td><td>$\sqrt{}$</td></y<>		$\sqrt{}$
	w Tx	Accept	2	2	0		
	Corner chipping	Х	1	≤1/6L	1		√
	(ITOpins position)	Y	Y≤1/2W	1/2W <y≤w< td=""><td>W <y< td=""><td>٧</td></y<></td></y≤w<>	W <y< td=""><td>٧</td></y<>		٧
11.6.		Accept	2	1	0		
3.2	Z	at the same	time it should ne corner chip	not enter into b	osition as per 6.3.3; black border of the electric connection 3.1.		
	Chipping in sealed	Х	/	≤1/8L	/		
	area (outside chipping)	Y (outside chipping)	Not enter into	Enter Y≤H	H <y< td=""><td></td><td></td></y<>		
11.6.		Y (inside chipping)	sealant	Enter Y≤1/2H	1/2H <y< td=""><td></td><td>1</td></y<>		1
3.3		Z	≤T	≤1/2T	1		$\sqrt{}$
	Chipping in sealed area (inside chipping)	Accept	2	1	0		
		area are sam	e. When the c s per the chip	chipping occurre	g on edge sealing ed in the opposite of -conduction side		
	conductive side	Х	1	≤1/6L	/		
11.6.	(back side chipping	Y	Y≤1/3W 1/3W 2/3W <y 3w<="" td="" ≤2=""><td>2/3W <y< td=""><td></td><td>√</td></y<></td></y>	2/3W <y< td=""><td></td><td>√</td></y<>		√	
3.4	Z	Accept	2	2	0		
	X	(Chipping into I	TO side ,refer t	o 6.3.1		
	Protruding LCD	X	1	≤1/8L	1		
	poor cutting and LCD burrs	Y	≤1/6W	1/6W <y≤1 5w<="" td=""><td>1/5W <y< td=""><td></td><td>V</td></y<></td></y≤1>	1/5W <y< td=""><td></td><td>V</td></y<>		V
11.6. 3.5		Z	1	1	1		,
		Accept	1	1	1		
		the outside pr	otruding conti	ol as per the to	lerance of drawing.		
11.6. 3.6	Crack		NG, but to ou		n; the crack expand nfirmed as per the		√

Remark:1)X means the length of chipping; Y means the width; Z means the thickness; W means the step width of the two glasses; H means the distance from the glass edge to the seal inner edge;

t means glass thickness.



11.6.4 Backlight components

No.	Item	Description	Accepted criterion	MAJ	MIN
11.6.4.1	No backlight wrong Color	/	Rejected	√	
11.6.4.2	Color deviation	When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing.	Refer to sample and drawing.		√
11.6.4.3	Brightness deviation	When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over ±40% than its typical value.	Refer to sample and drawing.		V
11.6.4.4	Uneven brightness	Uneven on the same LCD and out of the specification of the drawing. The no specification evenness= (the max value-the min value)/ mean value< 70%.	Refer to sample and drawing.		V
11.6.4.5	Spot/line /scratch	When power on, it has dirty spot, scratches and so on spot and line defects.	Refer to 6.2.2		√

11.6.5 Metal frame (Metal Bezel)

No.	Item	Description	Accepted criterion	MAJ	MIN
11.6.5.1	Material & surface treatment	Metal frame/surface treatment do not conform to the specifications.	Rejected	√	
11.6.5.2	Tab twist Unconformity/ Tab not twisted	Wrong twist method or direction and twist tabs are not twisted as required.	Rejected	√	
11.6.5.3	Bezel paint loss	1.Front surface: Paint peel off and scratch to the bottom Dot:D≤0.5mm, exceeds 3;			1
11.6.5.4	Bezel scratch	Line:L≤3.0mm,W≤0.05mm exceeds 2; 2.Front dent, air bubble and side with paint	Rejected		√
11.6.5.5	Painting peel off, discoloration, dent, and scratch	peeling off scratch to the bottom Dot: D≤1.0mm, exceeds 3; Line:L≤10.0mm,W≤0.05mm, exceeds 2;			V
11.6.5.6	Burr	Burr(s) on metal bezel is so long as to get into viewing area.	Rejected		√

11.6.6 FPC

No.	Item	Description	Accepted criterion	MAJ	MIN
11.6. 6.1	Model & P/N	Material model & P/N	Keep the same with drawing and technical requirement	√	
11.6. 6.2	Dimension/ position	Dimension in drawing spec f w H Remark: H=ITO pin length f=FPC width W=ITO pin width	f≤1/3w, h ≤1/3H, dimension in drawing spec-> OK Conducive material and ITO/PDA connective area must over than 1/2. Entire dimension must be in spec tolerance.		√
11.6. 6.3	FPC appearance	Hot pressing material get broken, folding line open; FPC golden finger oxidate, broken ,scratch ,foreign material which cause line short	Broken length<2mm; FPC line is OK- > Accepted Crack and line broken-> Rejected		√
11.6. 6.4	FPC burr	Burr near FPC edge area	When cover line and burr length ≤1.0mm->Accepted		√
11.6. 6.5	FPC falling off	FPC bonding area falling off; silica gel breaking	Rejected		√
11.6. 6.6	Sealant missing ITO line	Sealant is not covered all ITO line	Rejected	√	
11.6. 6.7	Missing sealant	No sealant	Rejected	√	
11.6. 6.8	Sealant	Sealant height > product total height	Rejected	√	

11.6.7 SMT

No.	Item	Description	Accepted criterion	MAJ	MIN
11.6. 7.1	Soldering bridge	Solder between adjacent pads and components	Rejected		√
11.6. 7.2	Solder ball/splash	Solder ball/tin dross causing short circuit at the solder point. There are active solder ball and splash.	Rejected		V
11.6. 7.3	Soldering excursion	Soldering slant > 1/3 soldering pad 「學學文庫」 「學學文庫」	Rejected		√
11.6.	Component	Component on PCB differs with drawing: wrong one, extra one, lack one, opposite polarity	Rejected	√	
7.4	wrong attaching	JUMP short circuit on PCB: extra soldering ,lack soldering.	Rejected	V	
11.6. 7.5	Component falling off	Soldering but component is missing	Rejected	√	
11.6. 7.6	Wrong component	Component model/spec differs from product specification	Rejected	√	

11.6.8 General Appearance

1.6.8 Ger	ieral Appearance				
No.	Item	Description	Accepted criterion	MAJ	MIN
11.6.8. 1	Dimension	According to drawing	Accepted	V	
11.6.8. 2	Surface stain	Defect mark or label are not removed residual glue, and finger print,etc;	Rejected		√
11.6.8. 3	Assembly foreign material	Dot/linear stain after assembly backlight and diffuse film TP assembly fogy stain	Invisible when power on->OK Refer to 6.2.2 dot/line spec		√
11.6.8. 4	Mixture	Different model product in the same shipment	Rejected	V	
11.6.8. 5	Product mark	Missing, unclear, incorrect, or misplaced part	Rejected		√
11.6.8. 6	Component mark	Silk screen mark clear, resistance measured value in spec	Accepted (Refer to customer special requirement		V
11.6.8. 7	Newton's rings	Area<1/6 screen area quantity≤1	Accepted		√
11.6.8. 8	Mura	1.In black display ND 5% invisible ->OK; visible->NG 2.Naked eyes inspection RGB display invisible Black display, area<1/4 screen area	Refer to limited sample		√
11.6.8. 9	Light leak	1.LCD edge(near backlight) shadow by LCD lamps irregular illuminate 2.Judge in black/white/gray display (slight leaky is yellowish, greenish, bluefish ->NG);	Refer to limited sample Tape 浮起漏光 Panel 側邊漏光		V
11.6.8. 10	Polarizer	1.Polarizer slant.Cover VA and not over LCD edge 2.No unmovable stain or finger print in polarizer VA 3.Bubble/warped but not enter VA	Accepted		√
11.6.8. 11	TP defect	1.TP crack 2.TP stain(fogy&unremovable) 3.TP glue overflow to VA	Rejected		√

Remark: Anything which is not clearly defined in 6.5~6.8 should refer to IPC-A-610E.Consumer Electronics, Non-consumer Electronics refer to class 1 and Industrial, Automobile refer to Class 2.

11.7 Others

Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.

12. HANDLING PRECAUTIONS

12.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly:

- .lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- •.Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you :

Connect any unused input terminal to VCC or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

12.4 Packing

Module employ LCD elements and must be treated as such.

- Avoid intense shock and falls from a height.
- •. To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

12.5 Caution for operation

- •.It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- •.An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- •.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- •.If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- •.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
- •. Usage under the maximum operating temperature, 50%Rh or less is required.
- •.When fixed patterns are displayed for a long time, remnant image is likely to occur.

12.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
- •. Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.
- •.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- .Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

12.7 Safety

- •.It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- •. When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. PRECAUTION FOR USE

- **13.1** A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.
- **13.2** On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.
- •. When a question is arisen in this specification.
- •. When a new problem is arisen which is not specified in this specifications.
- •. When an inspection specifications change or operating condition change in customer is reported to GTK, and some problem is arisen in this specification due to the change.
- •. When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. PACKING SPECIFICATION

Please consult our technical department for detail information.

15. INITIALIZATION CODE

TBD

16. HSF COMPLIANCE

•.This products complies with ROHS 2011/65/EU and 2015/863/EU \ REACH 1907/2006/EC requirements, and the packaging complies with 94-62-EC.